

## Diode

Silicon Carbide Schottky Diode

# IDH10G120C5

5<sup>th</sup> Generation CoolSiC<sup>™</sup> 1200 V SiC Schottky Diode

## **Final Datasheet**

Rev. 2.1 2017-07-21

# Industrial Power Control

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## CoolSiC<sup>™</sup> SiC Schottky Diode

#### Features:

- Revolutionary semiconductor material Silicon Carbide
- No reverse recovery current / No forward recovery
- Temperature independent switching behavior •
- Low forward voltage even at high operating temperature •
- Tight forward voltage distribution •
- Excellent thermal performance •
- Extended surge current capability
- Specified dv/dt ruggedness •
- Qualified according to JEDEC<sup>1)</sup> for target applications
- Pb-free lead plating; RoHS compliant

#### **Benefits**

- System efficiency improvement over Si diodes •
- Enabling higher frequency / increased power density solutions
- System size / cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- RelatedLinks: www.infineon.com/sic

#### **Applications**

- Solar inverters
- Uninterruptable power supplies
- Motor drives
- **Power Factor Correction**

#### Package pin definitions

- Pin 1 and backside cathode
- Pin 2 anode

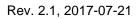


#### **Key Performance and Package Parameters**

Туре	V <sub>DC</sub>	I <sub>F</sub>	Q <sub>c</sub>	<b>T</b> <sub>j,max</sub>	Marking	Package
IDH10G120C5	1200V	10A	41nC	175°C	D1012C5	PG-TO220-2-1

1) J-STD20 and JESD22

**Final Data Sheet** 





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#### **Maximum ratings**

Parameter	Symbol	Value	Unit	
Repetitive peak reverse voltage	V <sub>RRM</sub>	1200	V	
Continues forward current for $R_{th(j-c,max)}$ $T_c = 155^{\circ}C, D=1$ $T_c = 135^{\circ}C, D=1$ $T_c = 25^{\circ}C, D=1$	I <sub>F</sub>	10.0 15.2 31.9	А	
Surge non-repetitive forward current, sine halfwave $T_{C}=25^{\circ}C$ , $t_{p}=10ms$ $T_{C}=150^{\circ}C$ , $t_{p}=10ms$	I <sub>F,SM</sub>	99 84	A	
Non-repetitive peak forward current $T_{\rm C} = 25^{\circ}$ C, $t_{\rm p}$ =10 µs	I <sub>F,max</sub>	711	А	
i <sup>2</sup> t value $T_{\rm C} = 25^{\circ}{\rm C}, t_{\rm p} = 10 \text{ ms}$ $T_{\rm C} = 150^{\circ}{\rm C}, t_{\rm p} = 10 \text{ ms}$	∫ i²dt	49 35	A²s	
Diode d <i>v</i> /d <i>t</i> ruggedness V <sub>R</sub> =0960V	dv/dt	80	V/ns	
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$	P <sub>tot</sub>	165	W	
Operating temperature	Tj	-55175	°C	
Storage temperature	T <sub>stg</sub>	-55150	°C	
Soldering temperature, wavesoldering only allowed at leads, 1.6mm (0.063 in.) from case for 10 s	T <sub>sold</sub>	260	°C	
Mounting torque M3 and M4 screws	М	0.7	Nm	

#### **Thermal Resistances**

Parameter	Symbol	Conditions min.		Value	Unit	
Falameter	Symbol		min.	typ.	max.	Onic
Characteristic	•					
Diode thermal resistance,	Ь		_	0.7	0.91	K/W
junction – case	R <sub>th(j-c)</sub>		-	0.7	0.91	17/17
Thermal resistance, junction – ambient	R <sub>th(j-a)</sub>	leaded	-	-	62	K/W



#### **Electrical Characteristics**

#### Static Characteristics, at $T_j=25$ °C, unless otherwise specified

Parameter	Symbol	Conditions min.		Value	Unit	
Falameter			min.	typ.	max.	Onic
Static Characteristic						
DC blocking voltage	V <sub>DC</sub>	$T_{\rm j} = 25^{\circ}{\rm C}$	1200	-	-	V
Diode forward voltage	V <sub>F</sub>	$I_{\rm F}$ = 10A, $T_{\rm j}$ =25°C	-	1.5	1.8	V
Didde forward voltage		$I_{\rm F}$ = 10A, $T_{\rm j}$ =150°C	-	2.0	2.6	
Reverse current	I <sub>R</sub>	V <sub>R</sub> =1200V, <i>T</i> <sub>j</sub> =25°C		4	62	μΑ
		V <sub>R</sub> =1200V, <i>T</i> <sub>j</sub> =150°C		22	320	

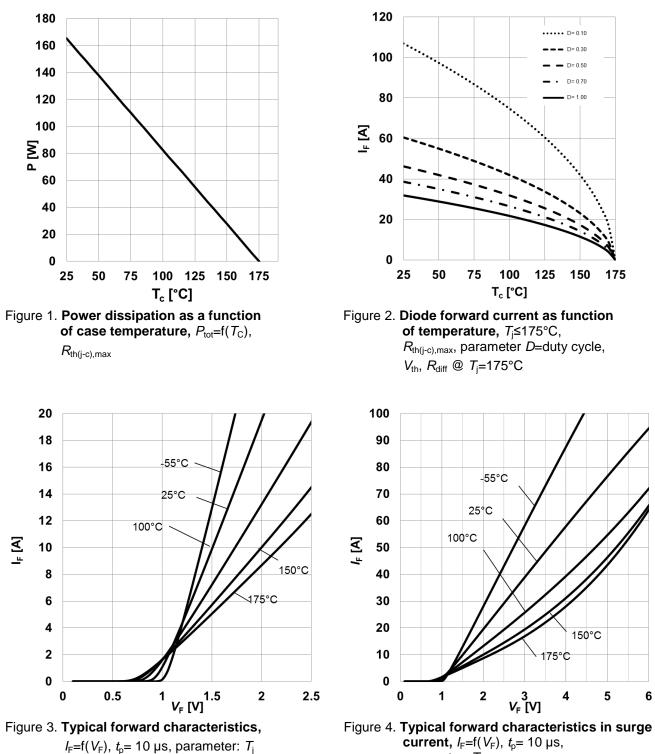
#### Dynamic Characteristics, at $T_j=25$ °C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
Farameter	Symbol		min.	typ.	max.	Onit
Dynamic Characteristics						
Total capacitive charge	Q <sub>C</sub>	$V_{\rm R}=800\rm V, \ T_{\rm j}=150\rm °C$ $Q_C = \int_0^{V_R} C(V)dV$	-	41	-	nC
Total Capacitance	С	V <sub>R</sub> =1 V, <i>f</i> =1 MHz V <sub>R</sub> =400 V, <i>f</i> =1 MHz V <sub>R</sub> =800 V, <i>f</i> =1 MHz		525 37 29	- -	pF



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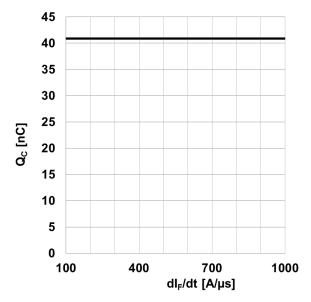
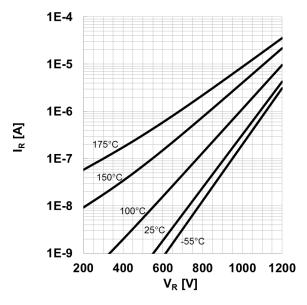
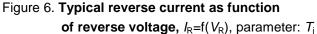
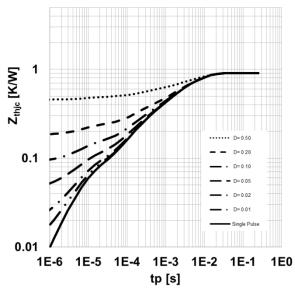
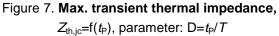


Figure 5. Typical capacitive charge as function of current slope<sup>1</sup>,  $Q_C=f(dI_F/dt)$ ,  $T_j=150^{\circ}C$ 1) Only capacitive charge, guaranteed by design.









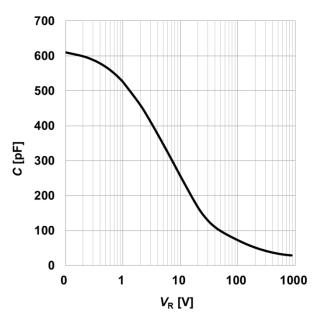


Figure 8. Typical capacitance as function of reverse voltage,  $C=f(V_R)$ ;  $T_j=25^{\circ}C$ ; f=1 MHz



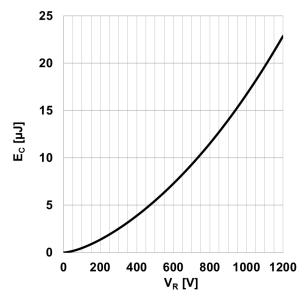


Figure 9. Typical capacitively stored energy as function of reverse voltage,

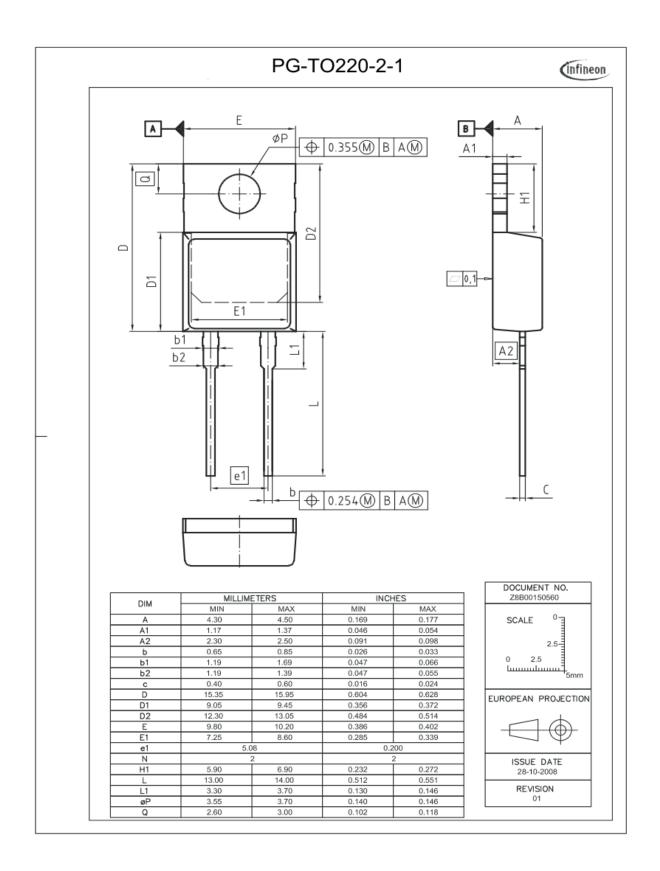
$$E_C = \int_0^{V_R} C(V) V dV$$

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#### **Revision History**

IDH10G120C5

#### Revision: 2017-07-21, Rev. 2.1

Previous Revision:					
Revision	Date	Subjects (major changes since last version)			
2.0	2015-07-22	Final data sheet			
2.1	-	Editorial Changes			

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